

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

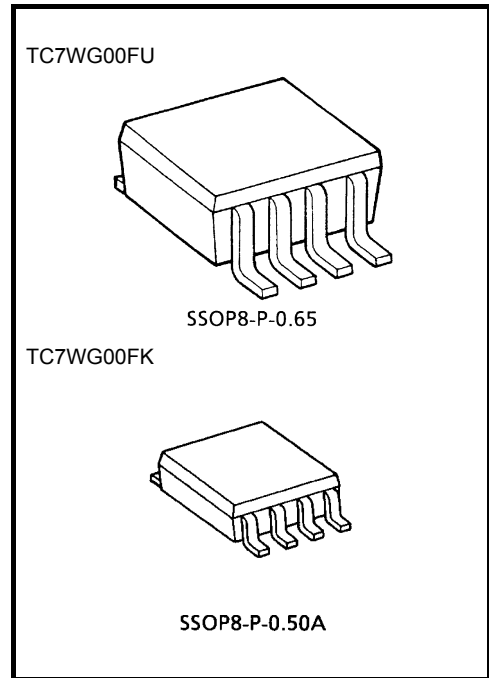
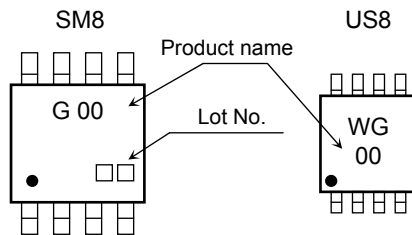
TC7WG00FU, TC7WG00FK

Dual 2-Input NAND Gate

Features

- High-level output current: $I_{OH}/I_{OL} = \pm 8 \text{ mA}$ (min) at $V_{CC} = 3 \text{ V}$
- High-speed operation: $t_{pd} = 2.5 \text{ ns}$ (typ.) at $V_{CC} = 3.3 \text{ V}, 15\text{pF}$
- Operating voltage range: $V_{CC} = 0.9\sim 3.6 \text{ V}$
- 5.5-V tolerant inputs
- 3.6-V power down protection outputs

Marking

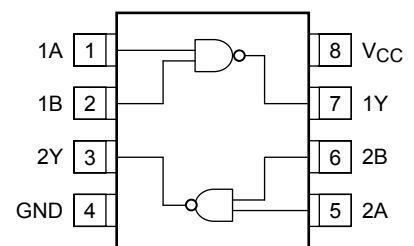


Weight
 SSOP8-P-0.65 : 0.02 g (typ.)
 SSOP8-P-0.50A : 0.01 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Value	Unit
Power supply voltage	V_{CC}	-0.5~4.6	V
DC input voltage	V_{IN}	-0.5~7.0	V
DC output voltage	V_{OUT}	-0.5~4.6 (Note 1)	V
		-0.5~ $V_{CC} + 0.5$ (Note 2)	
Input diode current	I_{IK}	-20	mA
Output diode current	I_{OK}	-20 (Note 3)	mA
DC output current	I_{OUT}	± 25	mA
DC V_{CC} / ground current	I_{CC}	± 50	mA
Power dissipation	P_D	300 (SM8) 200 (US8)	mW
Storage temperature	T_{stg}	-65~150	°C

Pin Assignment (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $V_{CC} = 0\text{V}$

Note 2: High or Low State. I_{OUT} absolute maximum rating must be observed.

Note 3: $V_{OUT} < \text{GND}$

IEC Logic Symbol



Truth Table

Inputs		Outputs
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

Operating Ranges

Characteristics	Symbol	Value	Unit
Power supply voltage	V_{CC}	0.9~3.6	V
Input voltage	V_{IN}	0~5.5	V
Output voltage	V_{OUT}	0~3.6 (Note 4)	V
		0~ V_{CC} (Note 5)	
Output Current	I_{OH}/I_{OL}	± 8.0 (Note 6)	mA
		± 4.0 (Note 7)	
		± 3.0 (Note 8)	
		± 1.7 (Note 9)	
		± 0.3 (Note 10)	
		± 0.02 (Note 11)	
Operating temperature	T_{opr}	-40~85	$^{\circ}C$
Input rise and fall time	dt/dV	0~10 (Note 12)	ns/V

Note 4: $V_{CC} = 0V$

Note 5: High or Low state.

Note 6: $V_{CC} = 3.0\sim 3.6V$

Note 7: $V_{CC} = 2.3\sim 2.7V$

Note 8: $V_{CC} = 1.65\sim 1.95V$

Note 9: $V_{CC} = 1.4\sim 1.6V$

Note 10: $V_{CC} = 1.1\sim 1.3V$

Note 11: $V_{CC} = 0.9V$

Note 12: $V_{IN} = 0.8\sim 2.0V$, $V_{CC} = 3.0V$

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40~85°C		Unit			
			V _{CC} (V)	Min	Typ.	Max	Min		Max		
Input voltage	High level	V _{IH}	—	0.9	V _{CC}	—	—	V _{CC}	—	V	
				1.1~1.3	V _{CC} × 0.7	—	—	V _{CC} × 0.7	—		
				1.4~1.6	V _{CC} × 0.65	—	—	V _{CC} × 0.65	—		
				1.65~1.95	V _{CC} × 0.65	—	—	V _{CC} × 0.65	—		
				2.3~2.7	1.7	—	—	1.7	—		
				3.0~3.6	2.0	—	—	2.0	—		
	Low level	V _{IL}	—	0.9	—	—	GND	—	GND		
				1.1~1.3	—	—	V _{CC} × 0.3	—	V _{CC} × 0.3		
				1.4~1.6	—	—	V _{CC} × 0.35	—	V _{CC} × 0.35		
				1.65~1.95	—	—	V _{CC} × 0.35	—	V _{CC} × 0.35		
				2.3~2.7	—	—	0.7	—	0.7		
				3.0~3.6	—	—	0.8	—	0.8		
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -0.02 mA	0.9	0.75	—	—	0.75	—	V
				I _{OH} = -0.3 mA	1.1~1.3	V _{CC} × 0.75	—	—	V _{CC} × 0.75	—	
				I _{OH} = -1.7 mA	1.4~1.6	V _{CC} × 0.75	—	—	V _{CC} × 0.75	—	
				I _{OH} = -3.0 mA	1.65~1.95	V _{CC} - 0.45	—	—	V _{CC} - 0.45	—	
				I _{OH} = -4.0 mA	2.3~2.7	2.0	—	—	2.0	—	
				I _{OH} = -8.0 mA	3.0~3.6	2.48	—	—	2.48	—	
	Low level	V _{OL}	V _{IN} = V _{IH}	I _{OL} = 0.02 mA	0.9	—	—	0.1	—	0.1	
				I _{OL} = 0.3 mA	1.1~1.3	—	—	V _{CC} × 0.25	—	V _{CC} × 0.25	
				I _{OL} = 1.7 mA	1.4~1.6	—	—	V _{CC} × 0.25	—	V _{CC} × 0.25	
				I _{OL} = 3.0 mA	1.65~1.95	—	—	0.45	—	0.45	
				I _{OL} = 4.0 mA	2.3~2.7	—	—	0.4	—	0.4	
				I _{OL} = 8.0 mA	3.0~3.6	—	—	0.4	—	0.4	
Input leakage current	I _{IN}	V _{IN} = 0~5.5V	0~3.6	—	—	±0.1	—	±1.0	μA		
Power off leakage current	I _{OFF}	V _{IN} = 0~5.5V V _{OUT} = 0~3.6V	0	—	—	1.0	—	10.0	μA		
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND	3.6	—	—	1.0	—	10.0	μA		

AC Characteristics (Input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40~85°C		Unit	
			V _{CC} (V)	Min	Typ.	Max	Min		Max
Propagation delay time	t_{pLH} t_{pHL}	$C_L = 10 \text{ pF}$, $R_L = 1 \text{ M}\Omega$	0.9	—	26.9	—	—	ns	
			1.1~1.3	—	10.9	20.7	1.0		38.6
			1.4~1.6	—	5.9	9.6	1.0		11.3
			1.65~ 1.95	—	4.5	7.0	1.0		7.5
			2.3~2.7	—	2.9	4.4	1.0		4.9
			3.0~3.6	—	2.2	3.5	1.0		4.1
		$C_L = 15 \text{ pF}$, $R_L = 1 \text{ M}\Omega$	0.9	—	30.0	—	—		—
			1.1~1.3	—	12.0	24.2	1.0		42.0
			1.4~1.6	—	6.5	10.5	1.0		12.6
			1.65~ 1.95	—	5.0	7.7	1.0		8.0
			2.3~2.7	—	3.2	4.9	1.0		5.6
			3.0~3.6	—	2.5	3.8	1.0		4.4
		$C_L = 30 \text{ pF}$, $R_L = 1 \text{ M}\Omega$	0.9	—	45.0	—	—		—
			1.1~1.3	—	18.0	33.4	1.0		63.2
			1.4~1.6	—	8.9	14.8	1.0		17.9
			1.65~ 1.95	—	6.9	10.3	1.0		10.8
			2.3~2.7	—	4.4	6.4	1.0		6.8
			3.0~3.6	—	3.5	4.9	1.0		5.4
Input capacitance	C_{IN}	—	3.6	—	3	—	—	pF	
Power dissipation capacitance	C_{PD}	(Note13)	0.9 ~ 3.6	—	10	—	—	—	pF

Note 13: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

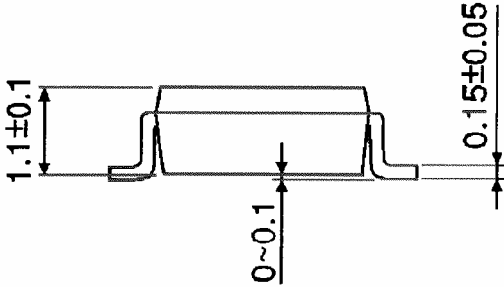
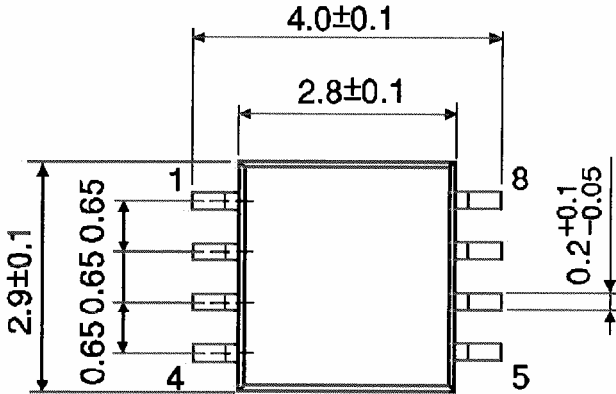
Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr.}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$$

Package Dimensions

SSOP8-P-0.65

Unit : mm

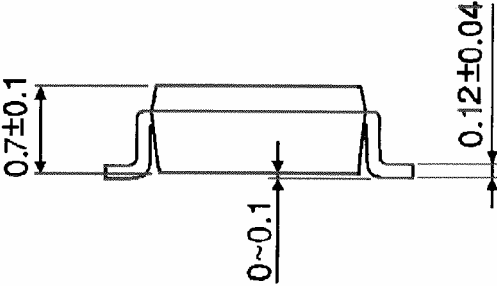
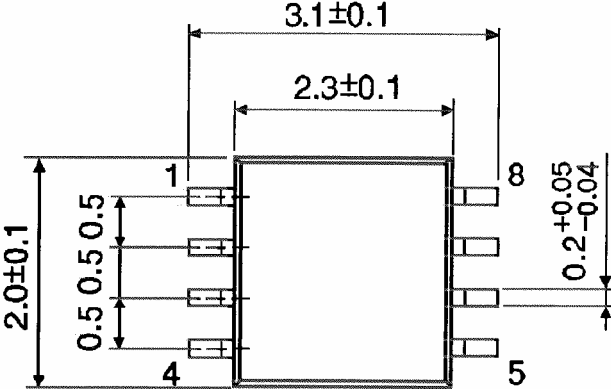


Weight: 0.02 g (typ.)

Package Dimensions

SSOP8-P-0.50A

Unit : mm



Weight: 0.01 g (typ.)

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20070701-EN GENERAL

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